

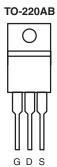
N-Channel 100-V (D-S) 175 °C MOSFET

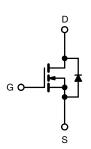
| PRODUCT SUMMARY | | | | |
|--|--------|--|--|--|
| V _{DS} (V) | 100 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$ | 0. 009 | | | |
| $R_{DS(on)}(\Omega)$ at $V_{GS} = 4.5 \text{ V}$ | 0. 020 | | | |
| I _D (A) | 100 | | | |
| Configuration | Single | | | |

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Maximum Junction Temperature
- Compliant to RoHS Directive 2002/95/EC







N-Channel MOSFET

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | |
|--|--|-----------------------------------|----------------------|------|--|
| Parameter | | | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 100 | V | | |
| Gate-Source Voltage | | V _{GS} | V _{GS} ± 20 | | |
| Continuous Drain Current (T _J = 150 °C) | T _C = 25 °C | I _D | 100 | A | |
| | T _C = 125 °C | | 75 ^a | | |
| Pulsed Drain Current | I _{DM} | 300 | A | | |
| Avalanche Current | L = 0.1 mH | I _{AS} | 75 | | |
| Single Pulse Avalanche Energy ^b | L = 0.1 IIII1 | E _{AS} | 280 | mJ | |
| Marrian Danier Dissipation | $T_C = 25$ °C (TO-220AB and TO-263) | P _D | 250 ^c | W | |
| Maximum Power Dissipation ^b | T _A = 25 °C (TO-263) ^d | ט י | 3.75 | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|---------------------------------|-------------------|-------|------|--|
| Parameter | | Symbol | Limit | Unit | |
| Junction-to-Ambient | PCB Mount (TO-263) ^d | R _{thJA} | 40 | °C/W | |
| | Free Air (TO-220AB) | ' 'thJA | 62.5 | | |
| Junction-to-Case | | R _{thJC} | 0.6 | | |

Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------------|---|------|-------|-------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V_{DS} $V_{GS} = 0 \text{ V, } I_{D} = 250 \mu\text{A}$ | | | | ., | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | | 4 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | V _{DS} = 100 V, V _{GS} = 0 V | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μΑ | |
| | | V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} = \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$ | 120 | | | Α | |
| | | V _{GS} = 10 V, I _D = 30 A | | 0.009 | | 1 | |
| | | V _{GS} = 4.5 V, I _D = 20 A | | 0.020 | | _ | |
| Drain-Source On-State Resistance ^a | R _{DS(on)} | V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C | | 0.023 | | Ω | |
| | | V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C | | 0.030 | | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 25 | | | S | |
| Dynamic ^b | | | | L | | | |
| Input Capacitance | C _{iss} | | | 4700 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 665 | | | |
| Reverse Transfer Capacitance | C _{rss} | 1 | | 265 | | | |
| Total Gate Charge ^c | Q_g | | | 105 | 160 | | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 50 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 85 \text{ A}$ | | 17 | | nC | |
| Gate-Drain Charge ^c | Q _{gd} | 1 | | 23 | | | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 12 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 50 \text{ V}, R_{L} = 0.6 \Omega$ | | 90 | 135 | | |
| Turn-Off DelayTime ^c | t _{d(off)} | $I_D \cong 85 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 55 | 85 | ns | |
| Fall Time ^c | t _f | 1 | | 130 | 195 | 1 | |
| Source-Drain Diode Ratings and Char | acteristics T _C | = 25 °C ^b | | | | | |
| Continuous Current | Is | | | | 85 | | |
| Pulsed Current | I _{SM} | | | | 240 | Α | |
| Forward Voltage ^a | V _{SD} | I _F = 85 A, V _{GS} = 0 V | | 1.0 | 1.5 | ٧ | |
| Reverse Recovery Time | t _{rr} | | | 85 | 140 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, dI/dt = 100 A/μs | | 4.5 | 7 | Α | |
| Reverse Recovery Charge | Q _{rr} | 1 | | 0.17 | 0.35 | μC | |

Notes:

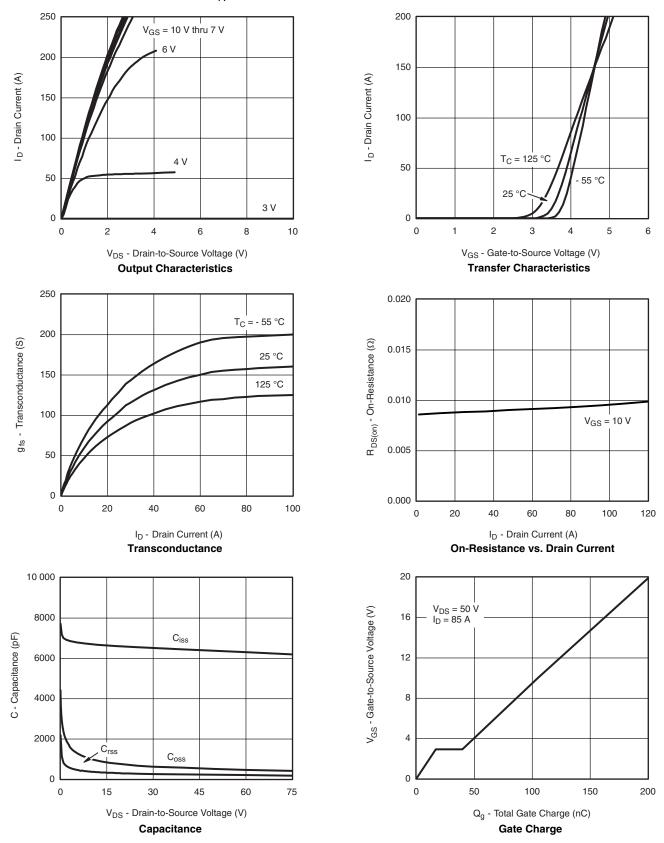
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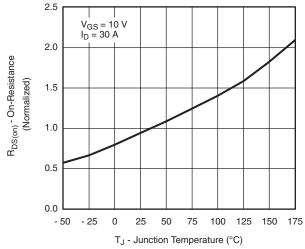
TYPICAL CHARACTERISTICS $T_A = 25$ °C, unless otherwise noted



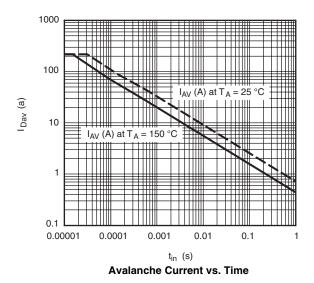
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TYPICAL CHARACTERISTICS $T_A = 25 \, ^{\circ}C$, unless otherwise noted

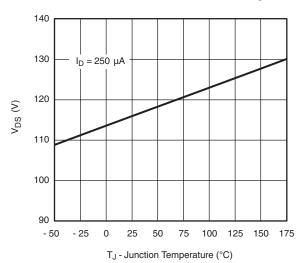


On-Resistance vs. Junction Temperature



T_J = 150 °C T_J = 25 °C T_J = 25 °C T_J = 25 °C V_{SD} - Source-to-Drain Voltage (V)

Source-Drain Diode Forward Voltage

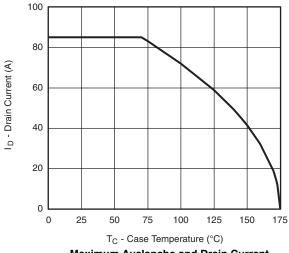


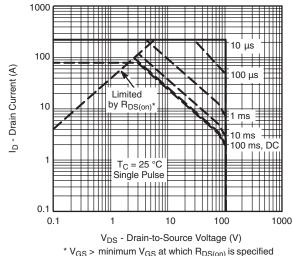
T_J - Drain-Source Breakdown vs. Junction-Temperature

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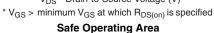


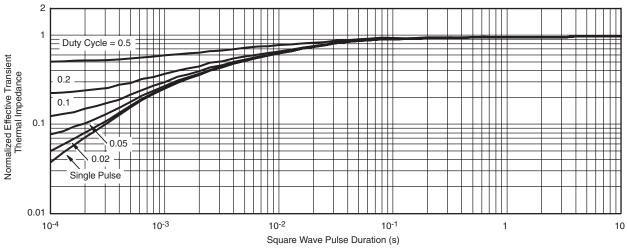
THERMAL RATINGS





Maximum Avalanche and Drain Current vs. Case Temperature





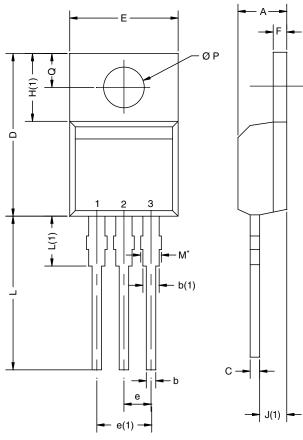
Normalized Thermal Transient Impedance, Junction-to-Case

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5



TO-220AB



| - e(| 1) — | |
|------|------|----|
| | | |
| | | D2 |
| | | |

| | MILLIMETERS | | INC | HES |
|--|-------------|-------|-------|-------|
| DIM. | MIN. | MAX. | MIN. | MAX. |
| Α | 4.25 | 4.65 | 0.167 | 0.183 |
| b | 0.69 | 1.01 | 0.027 | 0.040 |
| b(1) | 1.20 | 1.73 | 0.047 | 0.068 |
| С | 0.36 | 0.61 | 0.014 | 0.024 |
| D | 14.85 | 15.49 | 0.585 | 0.610 |
| D2 | 12.19 | 12.70 | 0.480 | 0.500 |
| Е | 10.04 | 10.51 | 0.395 | 0.414 |
| е | 2.41 | 2.67 | 0.095 | 0.105 |
| e(1) | 4.88 | 5.28 | 0.192 | 0.208 |
| F | 1.14 | 1.40 | 0.045 | 0.055 |
| H(1) | 6.09 | 6.48 | 0.240 | 0.255 |
| J(1) | 2.41 | 2.92 | 0.095 | 0.115 |
| L | 13.35 | 14.02 | 0.526 | 0.552 |
| L(1) | 3.32 | 3.82 | 0.131 | 0.150 |
| ØР | 3.54 | 3.94 | 0.139 | 0.155 |
| Q | 2.60 | 3.00 | 0.102 | 0.118 |
| ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471 | | | | |

DWG: 5471

Note

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM

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DMN2080UCB4-7 DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 DMN2990UFB-7B
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